⁰⁸ 120628

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

opplication of:

Warren M. Farnworth Alan G. Wood Trung Tri Doan David R. Hembree

(Parent Serial No: 073,003)

Filed: Concurrently herewith

Title (as amended):

BONDPAD ATTACHMENTS

HAVING SELF-LIMITING

PROPERTIES FOR

PENETRATION OF

SEMICONDUCTOR DIE

Attorney Docket No.: 91-62.7

Paper No.

Group Art Unit: unassigned

Examiner: unassigned

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June 7, 1993

Commissioner of Patents and Trademarks Washington, D.C. 20231

Dear Commissioner:

PRELIMINARY AMENDMENT

Prior to examining the captioned case, please amend the claims as follows:

In the Title:

Cancel "USED TO TEMPORARILY CONNECT" and insert -- HAVING

In the Specification:

Page 2, line 2 (first line of the paragraph under the heading, "CROSS-REFERENCE TO RELATED APPLICATION"), after "This is a" insert -- Continuation to U.S. Patent Application No. 8/73,003, filed 6/7/93. U.S. Patent Application No. 8/73,003 is a --;

NE Not in line Page 2, line 8, cancel "electrical test equipment for";

Page 2, lines 10-13, cancel ", which utilize conductive polymers, and which are used to perform dynamic burn-in and full electrical/performance/speed testing on discrete nonpackaged or semi-packaged dies.", and insert -- for establishing electrical